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1752-2 1.1		Web Site for Informat		n Type * ribute	-		claration Class * ss 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa								
Supplier Information															
Company Name *	Company Unique ID		Unique ID Au	Response Date *				Response Document ID							
SEMTECH CORPORATION	ON	00-847-9941		DUNS	2014-04-20										
Contact Name *		Title - Contact		Phone - Cor	Email	- Contac	t *		D !: (0 1 1	Δ 11				
ROYA MOTAMEDI		QA Customer Servic	e Specialis	805-389-2742		rmotamedi@semtech.com			om	Duplicate	e Contact	-> Autno	orizea Re	presentative	
Authorized Representative 3		Title - Representative	е	Phone - Representative *		Email - Representative *			*	Supplier Comments or URL for Additional Information					
ROYA MOTAMEDI		QA Customer Service	e Specialis	805-389-274	2	rmota	medi@se	emtech.c	om						
Requester Item Number		Mfr Item Number		Mfr Item Name	;	Effectiv	e Date	Version Manu		acturing Site	Weight *	UC	OM	Unit Type	
		RClamp0503N.TCT		Low Capacita	ſ			China		2.387	mg	3	Each		
Alternate Recommend	ation				Alternate Item C			Item Co	mments	•			•		
Manufacturing Proces	ss In	formation				•									
Ferminal Plating / Grid Array Material			Terminal Base Alloy		J-STD-020 MSL Ra	ating	g Peak Process Bod		Temper	ature Max Time	e Max Time at Peak Tem		Number of	of Reflow Cycles	
Nickel/Palladium/Gold (Ni/Pd/Au)			CU Alloy		1			260 C			30 s	econds	3		
Comments RClamp0503N.TCT is R	EACH	I-compliant product	t, per EU F	Regulation E0	C1907/2006 to inc	lude re	ecent add	dition of S	SVHC	candidate list	of substan	ces in D	ecembei	2013.	

Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type *** Detailed Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a ?RoHS restricted substance?) in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier?s liability and the Company?s remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. 1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance * Accepted **RoHS Declaration *** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. **Declaration Signature**

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem			Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Evennt	Weight	Unit of	Tolerance		PPM
	Name			Material	weight	Measure			Levei	Substance Category			Substance	CAS	Exempt	weight	Measure	-	+	FFIVI
+1 -1	Die	+M	-M	Doped Silicon	0.0799	mg	+C	-C	Supplier		+S	-S	Si	7440-21-3		0.0799	mg		;	33,479
+1 -1	Lead frame	+M	-M	C7025	0.85995	mg	+C	-C	Supplier		+S	-S	Cu	7440-50-8		0.8247	mg		,	345,54
	-			•	•			·			+S	-s	Si	7440-21-3		0.0062	mg			2,612
							+C	-C	В	Nickel (external applic	+S	-s	Nickel	7440-02-0		0.0275	mg			11,530
							+C	-C	Supplier		+S	-S	Mg	7439-95-4		0.0015	mg		ļ	631
		+M	-M	Ni/Pd/Au Plating	0.02205	mg	+C	-C	В		+S	-s	Nickel	7440-02-0		0.0199	mg			8,331
				•	•		+C	-C	Supplier	Middle plating	+S	-S	Pd	7440-05-3		0.0018	mg			758
							+C	-C	Supplier	Outer Plating	+S	-S	Au	7440-57-5		0.0004	mg			151
+1 -1	Bonding wire	+M	-M	Gold	0.0263	mg	+C	-C	Supplier		+S	-S	Au	7440-57-5		0.0263	mg			11,020
+1 -1	Molding compound	+M	-M	EME-G770HCD	1.3827	mg	+C	-C	Supplier		+S	-S	Silica fused	60676-86-0		1.2929	mg		,	541,70
	-			-				-			+S	-S	Epoxy resin	Proprietary		0.0415	mg			17,381
											+S	-S	Phenol resin	Proprietary		0.0415	mg			17,381
											+S	-S	С	1333-86-4		0.0069	mg			2,897
+1 -1	Die attached epoxy	+M	-M	8006NS	0.01569	4mg	+C	-c	Supplier		+S	-S	Treated Silica	Proprietary		0.0013	mg		,	526
											+S	-S	Glycol ethers	Proprietary		0.0031	mg			1,315
											+S	-S	Metal Oxide	Proprietary		0.0044	mg			1,841
											+S	-s	Curing agent & hardene	Proprietary		0.0013	mg			526
											+S	-S	epoxy resin	Proprietary		0.0056	mg			2,367